The First Smart Laser Processing Conference 2014



Organized by Japan Laser Processing Society

April 22 (Tuesday) to 24 (Thursday), 2014

http://www.jlps.gr.jp/slpc2014/





Venue: Pacifico Yokohama, Yokohama, Japan Co-located with Optics & Photonics International Congress 2014

Aim and Scope

Laser beam processing has played an important role in industrial fields of not only macro-products but also micro-products, and its technologies are essential to open the new strategies of smart manufacturing process. SLPC2014 deals with science and technology of smart laser materials processing including micro and macro laser processing. SLPC2014 is planned as a three-day event with a plenary session, oral sessions and poster session. The aim of this conference is to provide a forum for discussion of fundamental aspects of laser-matter interaction, the state-ofthe-art of smart laser processing, and topics for the next generation with fundamental scientists, end users and laser manufacturers. We expect that SLPC2014 would play an important role not only for understanding fundamental knowledge of laser processing but also forecasting future technologies and the future laser processing fields. During the conference, Optics and Photonics International Exhibition is held jointly at the conference site.

Topics and Fields:

Micro Nano Processing **Bio Application** Functional Surface Manufacturing Additive Manufacturing Advanced Lasers and Optical Technologies Others

Short Wavelength Application Ultrashort Pulsed Laser Processing Laser Peening and Related Phenomena **CFRP Processing Industrial Applications**

Important Dates

Abstract Due Date: Early Registration Due Date: Registration Due Date for Presenting Authors: March 20, 2014, Thursday JST Manuscript Due Date:

January 31, 2014, Friday JST (Extended) March 20, 2014, Thursday JST March 31, 2014, Monday JST

The Second Announcement and Call for Papers SLPC 2014

Committees

Conference Chairs: Yasuhiro Okamoto, Okayama University, Japan

Reinhart Poprawe, Fraunhofer Institute for Laser Technology, Germany

Program Committee:

Chair: Masahiro Tsukamoto, Osaka University, Japan

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Co-operating Societies and Media Partners

Association of Laser Users, AILU

Club Laser et Procédés, CLP

Industrial Laser Solutions for Manufacturing

Laser Institute of America, LIA

Optoelectronics Industry and Technology Development Association, OITDA

Swissphotonics

Wissenschaftlichen Gesellschaft Lasertechnik e.V., WLT















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Invited Speakers (More to be added)

Chung-Wei Cheng, Industrial Technology Research Institute, Taiwan

Bo Gu, Bos Photonics, USA

Shuili Gong, Beijing Aeronautical Manufacturing Technology Research Institute, China

Peter R. Herman, University of Toronto, Canada

Karsten Koenig, University of Saarland, Germany

Lin Li, The University of Manchester, UK

John Lopez, University of Bordeaux, CNRS, France

Yongfeng Lu, University of Nebraska Lincoln, USA

Haibin Zhang, Electro Scientific Industries, Inc., USA

Reinhart Poprawe, Fraunhofer Institute for Laser Technology, Germany

Koji Sugioka, RIKEN, Japan

Paul J. L. Webster, Laser Depth Dynamics Inc., Canada

Minlin Zhong, Tsinghua University, China

Registration Fees

Society	Туре	Before/on March 20, 2014	After March 20, 2014
Member*	General	JPY 40,000-	JPY 44,000-
	Student	JPY 18,000-	JPY 21,000-
Non-member	General	JPY 45,000-	JPY 50,000-
	Student	JPY 21,000-	JPY 23,000-

^{*}Member: JLPS and cooperating societies of SLPC2014 and OPIC2014

Sponsors

We would like to encourage you to become SLPC2014 event sponsor. For the details, please contact SLPC2014 secretary.

Level	Price	Quantity
GOLD	JPY 200,000-	Open for 1 contribution
SILVER	JPY 100,000-	Open for 3 contributions
BRONZE	JPY 50,000-	Open for 10 contributions

Contact



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